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Team Nexperia

45 V, 100 mA NPN general-purpose transistors

Rev. 9 — 23 September 2014

Product data sheet

1. Product profile

1.1 General description

NPN general-purpose transistors in Surface-Mounted Device (SMD) plastic packages.

Type number ^[1]	Package			PNP complement
	NXP	JEITA	JEDEC	
BC847	SOT23	-	TO-236AB	BC857
BC847A				BC857A
BC847B				BC857B
BC847C				BC857C
BC847W	SOT323	SC-70	-	BC857W
BC847AW				BC857AW
BC847BW				BC857BW
BC847CW				BC857CW
BC847T	SOT416	SC-75	-	BC857T
BC847AT				BC857AT
BC847BT				BC857BT
BC847CT				BC857CT
BC847AM	SOT883	SC-101	-	BC857AM
BC847BM				BC857BM
BC847CM				BC857CM

Table 1. Product overview

[1] Valid for all available selection groups.

1.2 Features and benefits

- General-purpose transistors
- SMD plastic packages
- Three different gain selections
- AEC-Q101 qualified

1.3 Applications

General-purpose switching and amplification



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1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base		-	-	45	V
I _C	collector current			-	-	100	mA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$	[1]	110	-	800	
	h _{FE} group A			110	180	220	
	h _{FE} group B			200	290	450	
	h _{FE} group C			420	520	800	

[1] $T_{amb} = 25 \text{ °C}$ unless otherwise specified

2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
SOT23, S	OT323, SOT416		
1	base		
2	emitter	3	3
3	collector	1 2 006aaa144	1
SOT883			
1	base		
2	emitter		3
3	collector	2 Transparent top view	1

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3. Ordering information

Table 4. Ordering information

Type number ^[1]	Package	Package					
	Name	Description	Version				
BC847	-	plastic surface-mounted package; 3 leads	SOT23				
BC847A	_						
BC847B	_						
BC847C	_						
BC847W	SC-70	plastic surface-mounted package; 3 leads	SOT323				
BC847AW	_						
BC847BW	_						
BC847CW	_						
BC847T	SC-75	plastic surface-mounted package; 3 leads	SOT416				
BC847AT	_						
BC847BT	_						
BC847CT	1						
BC847AM	SC-101	leadless ultra small plastic package; 3 solder lands;	SOT883				
BC847BM		body $1.0 \times 0.6 \times 0.5$ mm					
BC847CM	7						

[1] Valid for all available selection groups.

4. Marking

Table 5. Marking codes

Type number	Marking code ^[1]	Type number	Marking code ^[1]
BC847	1H*	BC847T	1N
BC847A	1E*	BC847AT	1E
BC847B	1F*	BC847BT	1F
BC847C	1G*	BC847CT	1G
BC847W	1H*	BC847AM	D4
BC847AW	1E*	BC847BM	D5
BC847BW	1F*	BC847CM	D6
BC847CW	1G*		

[1] * = placeholder for manufacturing site code

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Limiting values 5.

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	50	V
V _{CEO}	collector-emitter voltage	open base		-	45	V
V _{EBO}	emitter-base voltage	open collector		-	6	V
I _C	collector current			-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$		-	200	mA
I _{BM}	peak base current	single pulse; $t_p \le 1 \text{ ms}$		-	100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1]			
	SOT23			-	250	mW
	SOT323			-	200	mW
	SOT416			-	150	mW
	SOT883		[2]	-	250	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	+150	°C
T _{stg}	storage temperature			-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB with 60 µm copper strip line, standard footprint.

Thermal characteristics 6.

Table 7.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]				
	SOT23			-	-	500	K/W
	SOT323			-	-	625	K/W
	SOT416			-	-	833	K/W
	SOT883		[2]	-	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB with 60 µm copper strip line, standard footprint.

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7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off	V _{CB} = 30 V; I _E = 0 A		-	-	15	nA
	current	$\label{eq:VCB} \begin{array}{l} V_{CB} = 30 \; V; \; I_E = 0 \; A; \\ T_j = 150 \; ^\circ C \end{array}$		-	-	5	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$		-	-	100	nA
h _{FE} DC currer	DC current gain	V_{CE} = 5 V; I_C = 10 μ A					
	h _{FE} group A	_		-	170	-	
	h _{FE} group B			-	280	-	
	h _{FE} group C			-	420	-	
	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		110	-	800	
h _{FE} group A h _{FE} group B h _{FE} group C	h _{FE} group A			110	180	220	
	h _{FE} group B			200	290	450	
			420	520	800		
V _{CEsat}	CEsat collector-emitter saturation voltage	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$		-	90	200	mV
		$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$	<u>[1]</u>	-	200	400	mV
V _{BEsat}	base-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	[2]	-	700	-	mV
	saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$	[2]	-	900	-	mV
V _{BE}	base-emitter voltage	$I_{C} = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	[2]	580	660	700	mV
		$I_{C} = 10 \text{ mA}; V_{CE} = 5 \text{ V}$		-	-	770	mV
f _T	transition frequency	$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz		100	-	-	MHz
C _c	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = 10 \text{ V}; \text{I}_{E} = \text{i}_{e} = 0 \text{ A}; \\ \text{f} = 1 \text{ MHz} \end{array}$		-	-	1.5	pF
C _e	emitter capacitance	$V_{EB} = 0.5 \text{ V}; \text{ I}_{C} = \text{i}_{c} = 0 \text{ A};$ f = 1 MHz		-	11	-	pF
NF	noise figure	$\label{eq:lc} \begin{array}{l} I_{C} = 200 \; \mu \text{A}; V_{CE} = 5 \; \text{V}; \\ R_{S} = 2 \; \text{k} \Omega; \text{f} = 1 \; \text{kHz}; \\ B = 200 \; \text{Hz} \end{array}$		-	2	10	dB

Table 8.Characteristics

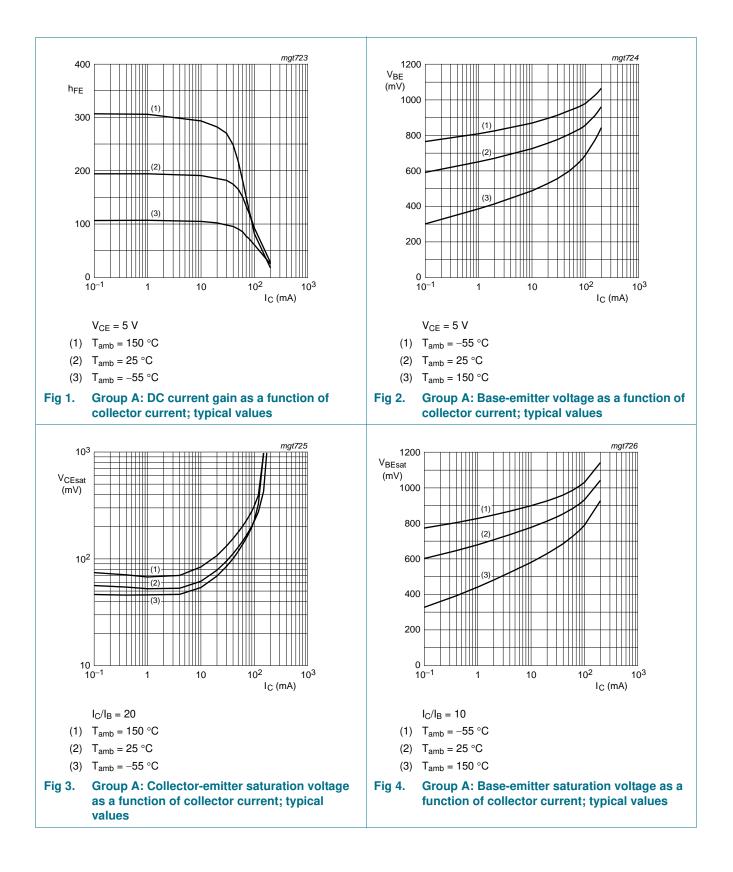
[1] Pulse test: $t_p \leq 300 \ \mu s$; $\delta = 0.02$.

[2] $$V_{\text{BE}}$$ decreases by approximately 2 mV/K with increasing temperature.

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BC847 series

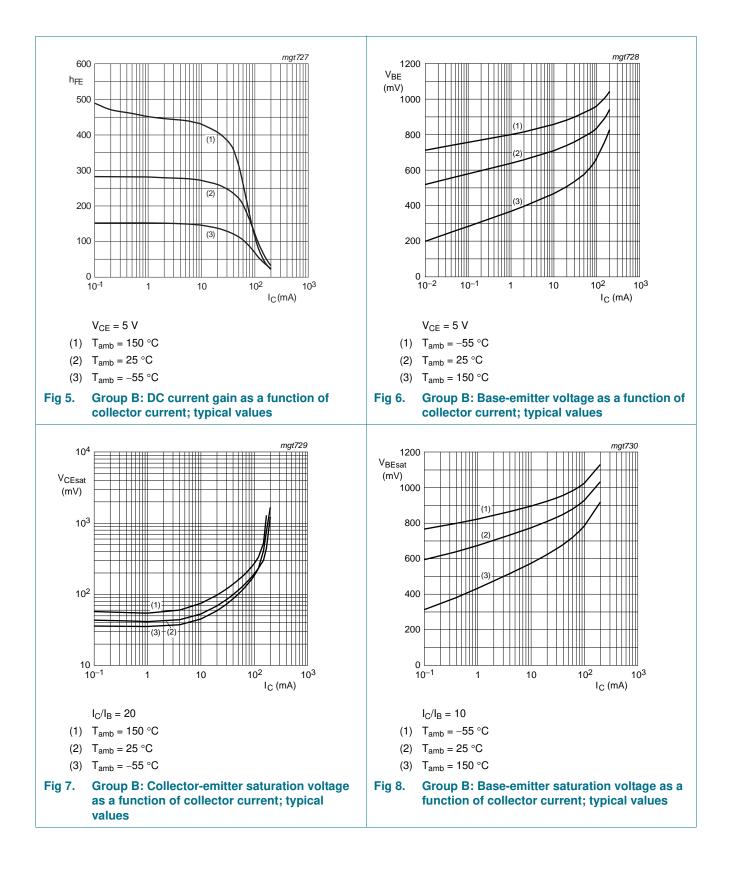
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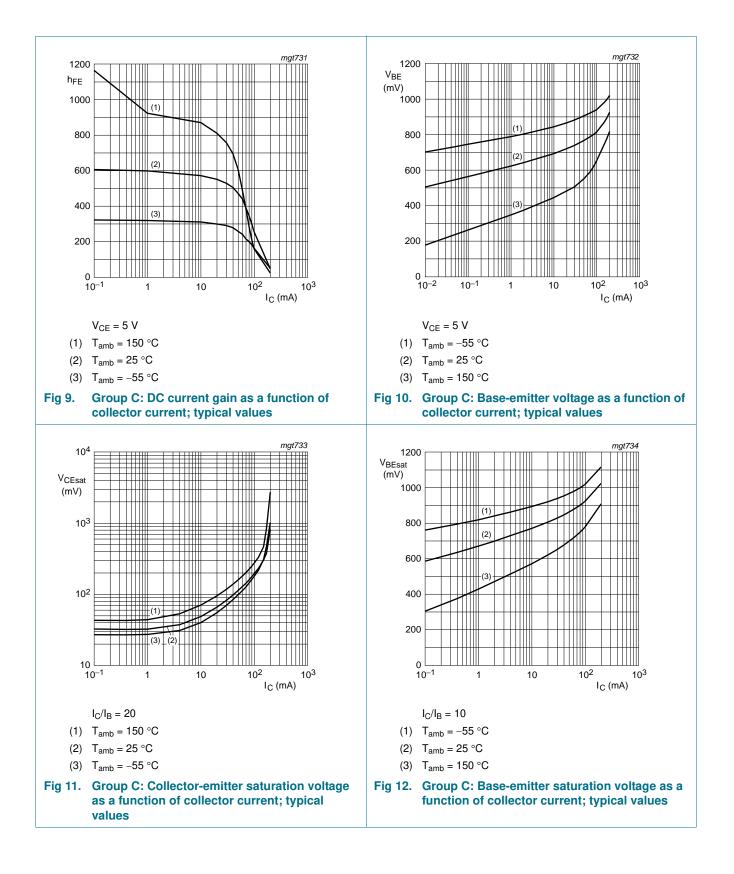
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BC847 series

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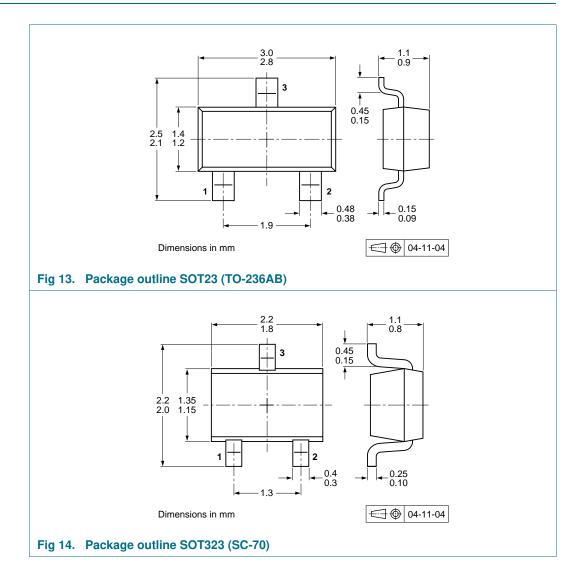
45 V, 100 mA NPN general-purpose transistors

8. Test information

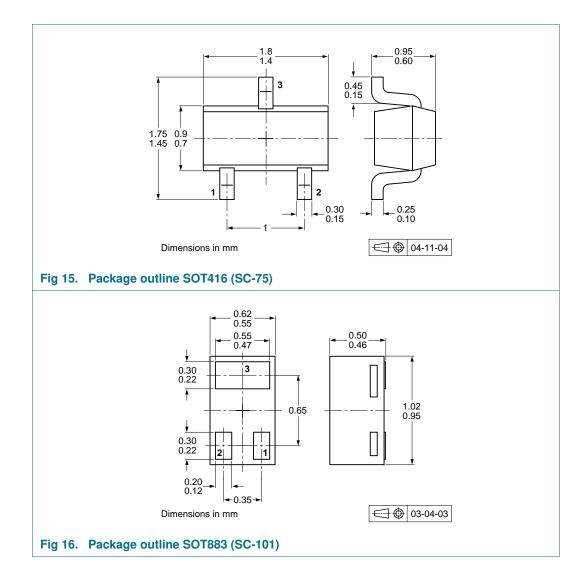
8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline

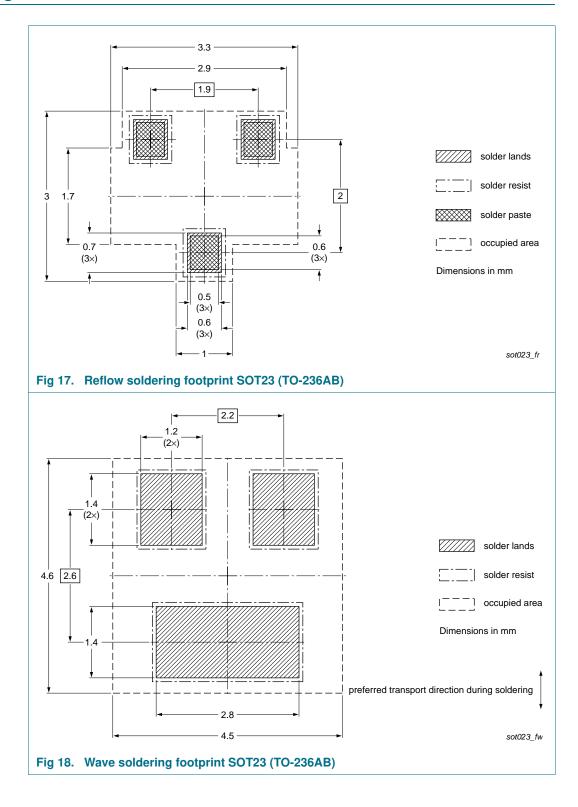


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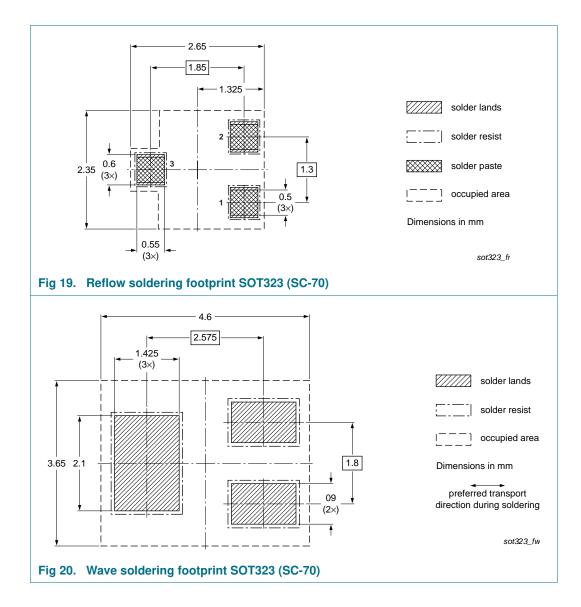
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10. Soldering



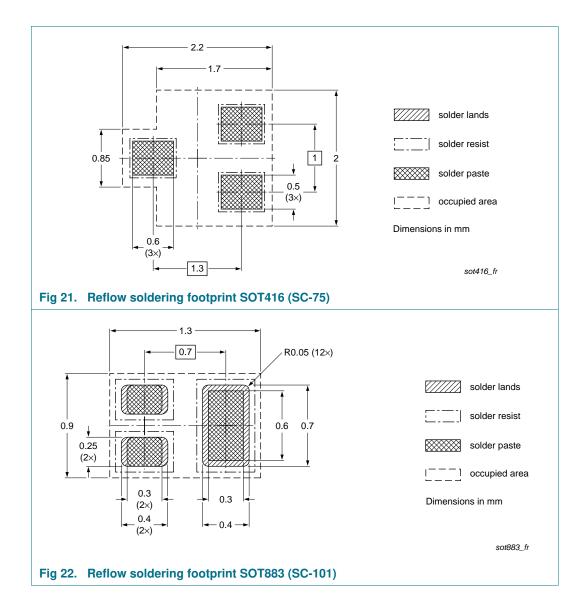
BC847_SER

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BC847_SER Product data sheet

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11. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BC847_SER v.9	20140923	Product data sheet	-	BC847_SER v.8
Modifications:	Section 1.2	Features and benefits": up	dated	
	Section 5 "Li	miting values": updated		
	• Figure 5: cor	rrected		
	Section 8 "Te	est information": added		
	Section 12 "	Legal information": updated	b	
BC847_SER v.8	20120820	Product data sheet	-	BC847_BC547_SER v.7
BC847_BC547_SER v.7	20081210	Product data sheet	-	BC847_BC547_SER v.6
BC847_BC547_SER v.6	20050519	Product data sheet	-	-

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12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 23 September 2014 Document identifier: BC847_SER